



## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re appli	cation of:	Art Unit: 2812						
Mitsuru O	KIGAWA	Examiner: Not assigned						
Serial No:	10/773,088							
Filed:	February 5, 2004							
For:	Semiconductor Integrated Device Including Support Substrate Fastened Using Resin, and Manufacturing Method Thereof	I hereby certify that this corresponden is being deposited with the United State Postal Service with sufficient postage first class mail in an envelope address to:						
TRANSM DISCLOS	ITTAL OF INFORMATION SURE STATEMENT	Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450, on March 1 2005						
Mail Stop		Date of Deposit Shindale Ferguson						
Commission	ner for Patents	Name March 1, 2005						
P.O. Box 14 Alexandria	, VA 22313-1450	Signature Date						
		$\cup$						
Dear Sirs:		· J						
mo apr inte me con	1. The information disclosure statement submitted herewith is being filed within three months of the filing date of the application other than a continued prosecution application, or within three months of the date of entry into the national stage of an international application, or before the mailing date of a first Office Action on the merits, or before the mailing of a first Office action after the filing of a request for continued examination under §1.114, whichever event occurs last. 37 C.F.R. §1.97(b).							
2. The information disclosure statement transmitted herewith is being filed after the period specified in §1.97(b), but before the mailing date of a final action under §1.113, or a notice of allowance under §1.311, or an action that otherwise closes prosecution in the application, whichever occurs first. A statement specified in §1.97(e) or a fee set forth in §1.17(p) is included. 37 C.F.R. §1.97(c).								
§1.97(e) STATEMENT								
I, tl	he person signing below, state:							

that each item of information contained in the information disclosure statement was first cited in the attached communication from a foreign patent office in a counterpart foreign application and that the communication is dated not more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(1).

OR

that no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification

§1.56(c) more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(2). OR FEE Attached is a fee set forth in 37 C.F.R. §1.17(p) for submission of an information disclosure statement under §1.97(c). (\$180.00). 3. The information disclosure statement transmitted herewith is being filed after the period specified in §1.97(c), but before, or simultaneously with the payment of the issue fee. A statement specified in §1.97(e) and a fee set forth in §1.17(p) are included. 37 C.F.R. §1.97(d). §1.97(e) STATEMENT I, the person signing below, state: that each item of information contained in the information disclosure statement was first cited in the attached communication from a foreign patent office in a counterpart foreign application and that the communication is dated not more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(1). OR that no item of information contained in the information disclosure statement was cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the person signing the certification after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in §1.56(c) more than three months prior to the filing of the statement. 37 C.F.R. §1.97(e)(2). AND FEE Attached is a fee set forth in 37 C.F.R. §1.17(p) for submission of an information disclosure statement under §1.97(d). (\$180.00). 4. If it should be determined that for any reason either an insufficient fee or an excessive has been paid, please charge any insufficiency or credit any overpayment necessary to ensure consideration of the information disclosure statement for the above-identified application to Deposit Account No. 50-1314. A copy of this petition is enclosed. 5. A list of 2 reference(s) is in the enclosed Form PTO-1449.

after making reasonable inquiry, no item of information contained in the information disclosure statement was known to any individual designated in

## NON-ENGLISH LANGUAGE REFERENCES

$\boxtimes$	Enclosed is a Taiwanese language Office Action for a counterpart application.
	The specification incorporates comments on the relevancy of Non-English language references.
	Set forth below are comments provided by the applicant's home country counsel on the relevancy of non-English language references:

By:

Respectfully submitted,

HOGAN & HARTSON L.L.P.

Date: March 1, 2005

Biltmore Tower 500 South Grand Avenue, Suite 1900 Los Angeles, CA 90071

Telephone: (213) 337-6700 Facsimile:

(213) 337-6701

Registration No. 44,228 Attorney for Applicant(s)

FORM PTO-1449			Docket Number (Optional) 81784.0301		Application Number 10/773,088				
O PIEFORMATION DISCLOSURE CITATION IN AN APPLICATION				Applicant Mitsuru OKIGAWA					
WAR 0 8 7005 (Use several sheets if necessary)				Filing Date February	5, 2004	Group Art Unit 2812			
THE THATEUR	U.S. PATENT DOCUMENTS								
EXAMINER INITIAL	DOCUMENT NUMBER	DATE		NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE		
	6,321,734	11/27/01	KAN	IINAGA, et al.					
	6,297,564	10/02/01	СНС	ING					
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EXAMINER DATE CONSIDERED

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to the applicant.